**VXIbus Overview**

**Introduction**

Prior to 1987 there existed only one major architecture standard for instruments...the General Purpose Interface Bus (GPIB). Although the GPIB was widely used, it did not address the need for portable test stations, nor for the market demand for faster, more cost-effective test solutions. In 1987, a consortium of test and measurement companies introduced VXIbus...a standard instrument architecture utilizing a modular platform.

The VXIbus (VMEbus eXtensions for Instrumentation) was developed to meet the need for portable applications and to provide a standard modular open architecture for integrating into the traditional GPIB test system and for stand-alone applications. It was designed to be an open architecture standard for instruments on a card, allowing an instrument from any manufacturer to operate in the same mainframe as another manufacturer’s instrument.

Rather than design an entirely new architecture, the VXIbus Consortium decided to enhance an existing standard that was well accepted in the data acquisition and high-speed computer markets...The VMEbus.

The VMEbus architecture, known for its excellent computer backplane, high-speed data rates of 40 MB/s (since enhanced to 320 MB/s), along with the necessary communication protocols, made it ideal for building instrument systems for high throughputs. VXIbus adds the ease-of-use features of intelligent GPIB instruments (for example, ASCII-level programming) into its message-based device, and also takes advantage of the high throughput capability of VME devices, which are programmed and communicate directly in binary (register-based devices).

Although VME is an excellent computer backplane, it is not adequate for instrumentation without further standardization. The VXIbus Consortium enhanced the VMEbus standard by further defining parameters to allow users to easily configure a workable system. Some of the enhancements added to the VMEbus standard were:

- Larger card options for higher performance instruments and to add shielding.
- Defining all signals on the backplane, avoiding potential conflicts due to user-defined signals on the VMEbus.
- Addition of EMC, cooling and power specifications to further ease system integration.
- Definition of communication protocols to ease integration with existing test systems.
- Addition of voltage rails for high-performance instruments.

**VXIbus Basics**

A VXIbus system or subsystem consists of a VXIbus mainframe, VXIbus devices, a VXIbus Slot 0 card, VXIbus resource manager, and host controller. The Slot 0 takes care of backplane management and includes things such as clock sources and arbitration for data movement across the backplane. The module that goes into this slot must perform these hardware functions in addition to its normal functions. The resource manager configures the modules for proper operation whenever the system is powered on or reset, allowing the user to build the test system software from a known starting point. The resource manager is not involved with the VXIbus system once normal operation begins. The VXIbus mainframe houses the VXIbus instruments and contains the power and cooling mechanism for these instruments, as well as the communication backplane.
The VXIbus was not designed to replace any existing standard, but instead as an additional tool to help in overall test or data acquisition solutions. To this end several methods of communicating with VXIbus devices were defined, enabling VXIbus solutions to be integrated with VMEbus, GPIB or as stand-alone portable solutions.

**Mechanical**

The VXIbus specification defines four module sizes. The two smaller sizes, A and B, are the defined VMEbus module sizes and are true VMEbus modules in every sense. The two larger sizes, C and D, are for higher performance instrumentation. Increased module spacing in the C- and D-size systems makes it possible to fully shield sensitive circuits for high performance measurements.

The C-size VXIbus footprint is the most common size today because it keeps systems to a smaller size than D, and allows the performance of VXIbus to be utilized (A and B being VMEbus devices). The only real D-size solutions found today are in legacy or custom-designed systems. B-size solutions are available on a limited basis, but consist mainly of VMEbus type or low-performance ECL instruments, and do not utilize the benefits of the VXIbus standard. Nearly all of the VXIbus products on the current market conform to the C-size footprint.

**Electrical**

Additional power supply voltages for powering analog and ECL circuits and instrumentation buses for measurement synchronization and triggering were added to the existing VMEbus signal, along with an analog sum-bus and a set of local bus lines for private module-to-module communication. The VXIbus specifies three 96-pin DIL connectors called P1, P2, and P3 (See Table 1). The P1 connector, the only mandatory one in VME or VXIbus, carries the data transfer bus (up to 24 bits addressing and 16 bits data), the interrupt bus, and some power.

**P2**

The optional P2 connector, available to all card sizes except A-size, expands the data transfer bus to its full 32-bit size. It also adds four additional power supply voltages, the local bus, the module identification bus (allows a VXIbus module’s slot number to be determined), and the analog summing bus (a current summing bus that runs the length of the backplane). Also, there are TTL and ECL trigger buses (running the length of the backplane with four trigger protocols defined) and a 10 MHz differential ECL clock signal (buffered to each slot).
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P3

The optional P3 connector is defined only for D-size cards.

Local Bus

The local bus adds significant capability to VXIbus measurement systems. It is a very flexible daisy-chain bus structure. Every inner slot in a VXIbus mainframe has a set of very short, 50 Ω transmission lines running between adjacent slots on either side. The local bus is 12 lines wide each direction through the P2 connector and an additional 24 lines wide through the P3 connector. This bus allows for adjacent modules to perform private communication.

Table 1 shows the actual pin outs of P1 and P2 for reference. P3 has not been shown, because of lack of use, but can be found in the VXIbus specifications.

EMC

The VXIbus specification stipulates radiated and conducted EMC limits for both generation and susceptibility. The importance of this part of the VXIbus specification cannot be overstated. EMC limits ensure that modules containing sensitive electronic circuits perform to expectations without interference from any other module operating in the system.

Power and Cooling

In a typical IEEE-488 rack-and-stack or VMEbus system, the system integrator must take a rigorous approach to ensure an environment cool enough for proper operation. Each instrument’s power dissipation, airflow and placement in the rack must be considered. The rack’s cooling capability must be factored in as well.

To ensure adequate cooling in a VXIbus system, the design process is simpler. Every vendor’s mainframe specification sheet provides a cooling graph for the worst-case module configuration. It is specified in terms of pressure across the module versus the airflow delivered. Each instrumentation manufacturer must also specify the airflow and back pressure required by the instrument for proper operation (normally for a 10 °C rise).
rise in temperature). The user would then plot the point of the module's airflow and back pressure specifications on the mainframe's cooling curve (See Figure 2) and, if located within the boundaries of the curve, the module is guaranteed to be compatible with the mainframe.

The power specification is another way the VXIbus makes the system integrator's job easier. Each VXIbus mainframe is specified for power delivered. Each power supply level has a peak dc current delivery and peak-to-peak dynamic current delivery. When selecting modules, voltage levels and current requirements are compared to the mainframe's capability. The VXIbus dynamic current specification ensures that the selected modules will not induce more ripple noise on the mainframe's power supply lines than any module is required to withstand.

**Communications**

Communications is another area of VXIbus standardization. VXIbus specifies several device types and protocols as well as communication handshakes, however, it leaves things flexible as far as how to control the VXIbus mainframe and devices -- open architecture. A VXIbus system or subsystem can be controlled using either an embedded or an external computer that can be operating system or platform independent, i.e., Windows, DOS, UNIX. If an external computer is used, the interface to the VXIbus mainframe can also be flexible, i.e., GPIB/VXI, MXI2/VXI, IEEE-1394/VXI, USB2.0/VXI or Ethernet/VXI. Any approach used has its own set of advantages and disadvantages dependent upon the overall system requirements. Each VXIbus mainframe must have a Slot 0 card. Because of available real estate, the Slot 0 functions are typically integrated with the interface to the external controller or with the embedded controller. The ease at which VXI can adapt to new communication busses and the fact that it is not dependent on a computer platform (e.g. PCI) gives it a distinct advantage when looking at systems requiring extended supportability.

There is one unique logical address (ULA) per VXIbus device (numbered from 0 to 255) and up to 256 devices in a VXIbus system. Typically a voltmeter, switch, or signal generator is a single device. It is important, however, to understand that ULAs or VXIbus instruments have no relationship to individual VXIbus
card slots. The VXIbus specification allows for several devices per card slot for improved portability and integration, or one instrument per several card slots for densely populated instruments.

VXI modules must have registers located at specific addresses, as shown in Figure 3. The upper 16 kB of the 64 kB A16 address space are reserved for VXIbus devices. The two most common types of VXIbus devices are register and message-based. A comparison follows.

Register-based Device

A register-based device is the simplest VXIbus device and most often is used as the basis for simple modules. A register-based device communicates only through register reads and writes. Module configuration on startup is controlled by VXIbus-defined configuration registers. Instrument control and data transfer occurs through the device-dependent registers in A16 space, or through extended memory space (A24/A32/A64). With the maturation of VXIplug&play drivers, programming register-based devices using standard function calls removes the need to understand a device’s register map. This greatly simplifies programming tasks.

Message-based Device

A message-based device has the most built-in intelligence in a VXIbus system. High-performance instruments, such as digitizers and waveform generators are typically available as message-based devices. Besides the basic configuration registers supported by the register-based device type, the message-based device has common communication elements and a Word Serial Protocol to allow ASCII-level communication with other message-based modules. This allows easier multi-manufacturer support, though at some sacrifice in speed to interpret the ASCII messages. Typically, a message-based device uses a microprocessor and is more costly than a register-based device. Since the Word Serial Protocol mandates only a byte transfer per transition, which then must be interpreted by the on-board microprocessor, message-based devices are typically limited in communication speeds. However, optional register-based access may be included on the module to bypass this bottleneck, while allowing ease of instrument set-up through the word serial protocol.

What is VXI 3.0?

The VXIbus specification was upgraded to revision 3.0 in January 2004. Two major enhancements were brought forward with the new specification. The backplane speed, which had been limited to 80 MB/s in revision 2.0, has been increased to 160 MB/s. This makes use of VME2e technology which defines data transfers on both clock edges.

In addition to the improved backplane speeds, VXI 3.0 adds 64-bit addressing. By defining A64 space, the amount of available memory increases by nine orders of magnitude. This ensures that larger systems utilizing modules with deep on-board memory, will not be limited by available addressable space. While VXI 3.0 compliant Slot 0’s will be needed to fully take advantage of the benefits of the new specs, it is completely backwards compatible with VXI 2.0 and existing mainframes and instrument modules can be used and coexist with VXI 3.0 hardware. This means that legacy systems can preserve their investment in existing hardware and also add newer technology as it becomes available. The VXIbus consortium’s adherence to backwards compatibility has allowed it to maintain its status as a reliable and established platform for systems designed today and in the future.

VXI 3.0 further entrenches the VXIbus platform as the choice for instrumentation for today and the future. Since the bus is isolated from that of the host PC, the platform can easily adapt to the latest technology trends in the commercial market without the need for an overhaul of the system design. This ensures that an investment in VXIbus instrumentation will continue to provide a path for growth throughout the life of any functional test system.